

Dual JK flip-flop with reset; negative-edge trigger**74LV107****FEATURES**

- Wide operating: 1.0 to 5.5 V
- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between $V_{CC} = 2.7$ V and $V_{CC} = 3.6$ V
- Typical V_{OLP} (output ground bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_{amb} = 25^\circ\text{C}$
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_{amb} = 25^\circ\text{C}$
- Output capability: standard
- I_{CC} category: flip-flops

DESCRIPTION

The 74LV107 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC/HCT107.

The 74LV107 is a dual negative-edge triggered JK-type flip-flop featuring individual J, K, clock ($n\bar{CP}$) and reset ($n\bar{R}$) inputs; also complementary Q and \bar{Q} outputs.

The J and K inputs must be stable one set-up time prior to the HIGH-to-LOW clock transition for predictable operation.

The reset ($n\bar{R}$) is an asynchronous active LOW input. When LOW, it overrides the clock and data inputs, forcing the Q output LOW and the \bar{Q} output HIGH.

Schmitt-trigger action in the clock input makes the circuit highly tolerant to slower clock rise and fall times.

QUICK REFERENCE DATA

$GND = 0$ V; $T_{amb} = 25^\circ\text{C}$; $t_r = t_f \leq 2.5$ ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t_{PHL}/t_{PLH}	Propagation delay $n\bar{CP}$ to nQ $n\bar{CP}$ to $n\bar{Q}$ $n\bar{R}$ to nQ , $n\bar{Q}$	$C_L = 15$ pF; $V_{CC} = 3.3$ V	15	ns
f_{max}	Maximum clock frequency		15	
C_I	Input capacitance		77	MHz
C_{PD}	Power dissipation capacitance per flip-flop	$V_I = GND$ to V_{CC} ¹	3.5	pF
			30	pF

NOTE:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW)

$$P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

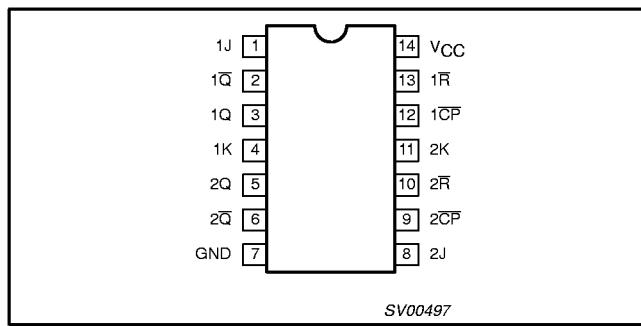
f_i = input frequency in MHz; C_L = output load capacitance in pF;

f_o = output frequency in MHz; V_{CC} = supply voltage in V;

$\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	-40°C to +125°C	74LV107 N	74LV107 N	SOT27-1
14-Pin Plastic SO	-40°C to +125°C	74LV107 D	74LV107 D	SOT108-1
14-Pin Plastic SSOP Type II	-40°C to +125°C	74LV107 DB	74LV107 DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV107 PW	74LV107PW DH	SOT402-1

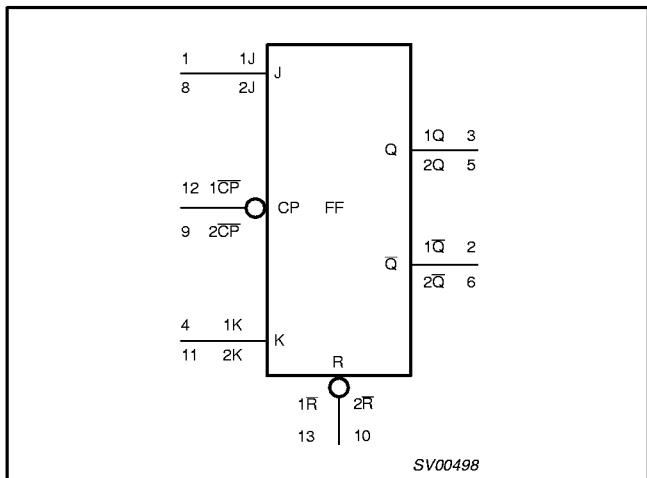
PIN CONFIGURATION**PIN DESCRIPTION**

PIN NUMBER	SYMBOL	FUNCTION
1, 8, 4, 11	1J, 2J, 1K, 2K	Synchronous inputs; flip-flops 1 and 2
2, 6	1Q, 2Q	Complement flip-flop outputs
3, 5	1Q, 2Q	True flip-flop outputs
7	GND	Ground (0 V)
12, 9	1CP, 2CP	Clock input (HIGH-to-LOW, edge-triggered)
13, 10	1R, 2R	Asynchronous reset inputs (active LOW)
14	V_{CC}	Positive supply voltage

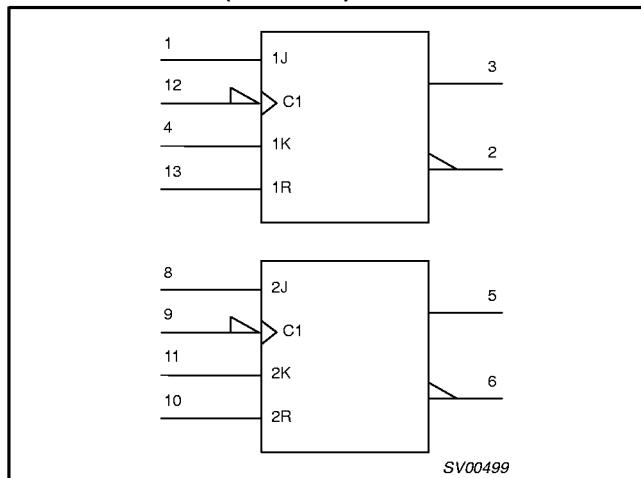
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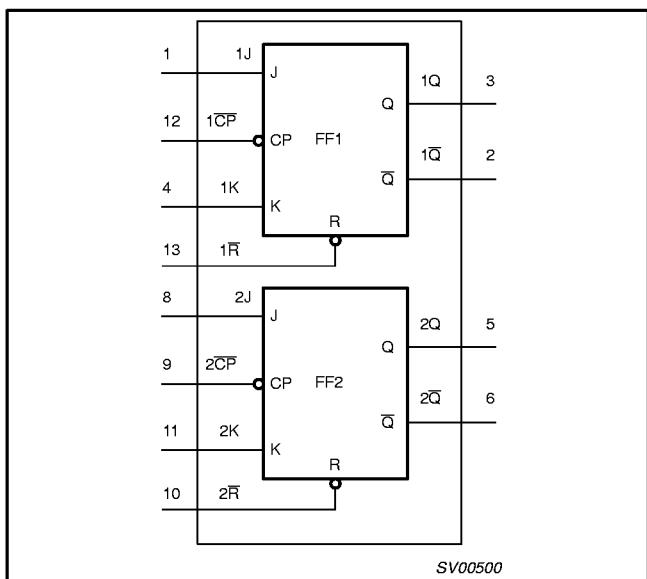
LOGIC SYMBOL



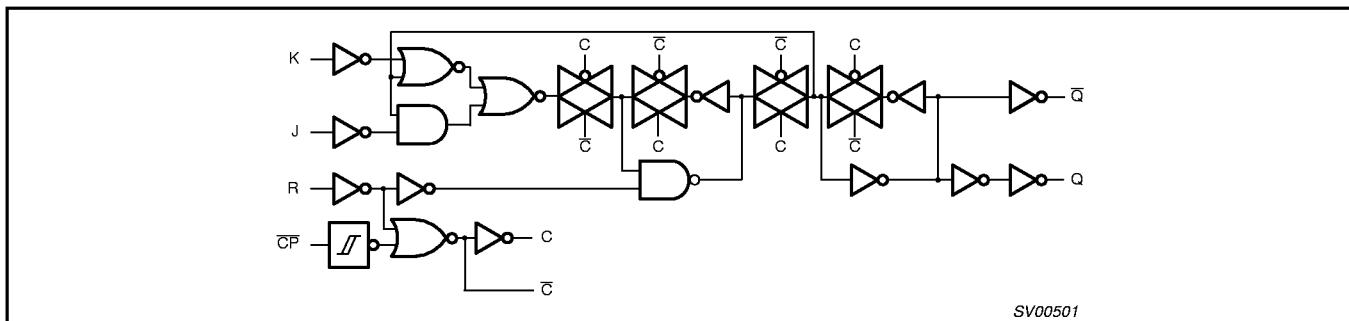
LOGIC SYMBOL (IEEE/IEC)



FUNCTIONAL DIAGRAM



LOGIC DIAGRAM



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FUNCTION TABLE

OPERATING MODES	INPUTS				OUTPUTS	
	nR	nCP	nJ	nK	nQ	nQ̄
Asynchronous reset	L	X	X	X	L	H
Toggle	H	↓	h	h	q̄	q
Load "0" (reset)	H	↓	l	h	l	H
Load "1" (set)	H	↓	h	l	H	l
Hold "no change"	H	↓	l	l	q	q̄

NOTES:

H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW CP transition

L = LOW voltage level

l = LOW voltage level one set-up time prior to the HIGH-to-LOW CP transition

q = lower case letters indicate the state of the referenced output one set-up time prior to the HIGH-to-LOW CP transition.

X = don't care

↓ = HIGH-to-LOW CP transition

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134).

Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
±I _{IK}	DC input diode current	V _I < -0.5 or V _I > V _{CC} + 0.5V	20	mA
±I _{OK}	DC output diode current	V _O < -0.5 or V _O > V _{CC} + 0.5V	50	mA
±I _O	DC output source or sink current – standard outputs	-0.5V < V _O < V _{CC} + 0.5V	25	mA
±I _{GND} , ±I _{CC}	DC V _{CC} or GND current for types with – standard outputs		50	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V _{CC}	DC supply voltage	See Note 1	1.0	3.3	5.5	V
V _I	Input voltage		0	–	V _{CC}	V
V _O	Output voltage		0	–	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times except for Schmitt-trigger inputs	V _{CC} = 1.0V to 2.0V V _{CC} = 2.0V to 2.7V V _{CC} = 2.7V to 3.6V V _{CC} = 3.6V to 5.5V	– – – –	– – – –	500 200 100 50	ns/V

NOTE:

- The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 5.5V.

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT	
			-40°C to +85°C			-40°C to +125°C			
			MIN	TYP ¹	MAX	MIN	MAX		
V _{IH}	HIGH level Input voltage	V _{CC} = 1.2 V	0.9			0.9		V	
		V _{CC} = 2.0 V	1.4			1.4			
		V _{CC} = 2.7 to 3.6 V	2.0			2.0			
		V _{CC} = 4.5 to 5.5 V	0.7 * V _{CC}			0.7 * V _{CC}			
V _{IL}	LOW level Input voltage	V _{CC} = 1.2 V			0.3		0.3	V	
		V _{CC} = 2.0 V			0.6		0.6		
		V _{CC} = 2.7 to 3.6 V			0.8		0.8		
		V _{CC} = 4.5 to 5.5			0.3 * V _{CC}		0.3 * V _{CC}		
V _{OH}	HIGH level output voltage; all outputs	V _{CC} = 1.2 V; V _I = V _{IH} or V _{IL} ; -I _O = 100µA		1.2				V	
		V _{CC} = 2.0 V; V _I = V _{IH} or V _{IL} ; -I _O = 100µA	1.8	2.0		1.8			
		V _{CC} = 2.7 V; V _I = V _{IH} or V _{IL} ; -I _O = 100µA	2.5	2.7		2.5			
		V _{CC} = 3.0 V; V _I = V _{IH} or V _{IL} ; -I _O = 100µA	2.8	3.0		2.8			
		V _{CC} = 4.5 V; V _I = V _{IH} or V _{IL} ; -I _O = 100µA	4.3	4.5		4.3			
V _{OH}	HIGH level output voltage; STANDARD outputs	V _{CC} = 3.0 V; V _I = V _{IH} or V _{IL} ; -I _O = 6mA	2.40	2.82		2.20		V	
		V _{CC} = 4.5 V; V _I = V _{IH} or V _{IL} ; -I _O = 12mA	3.60	4.20		3.50			
V _{OL}	LOW level output voltage; all outputs	V _{CC} = 1.2 V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		0				V	
		V _{CC} = 2.0 V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		0	0.2		0.2		
		V _{CC} = 2.7 V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		0	0.2		0.2		
		V _{CC} = 3.0 V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		0	0.2		0.2		
		V _{CC} = 4.5 V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		0	0.2		0.2		
V _{OL}	LOW level output voltage; STANDARD outputs	V _{CC} = 3.0 V; V _I = V _{IH} or V _{IL} ; I _O = 6mA		0.25	0.40		0.50	V	
		V _{CC} = 4.5 V; V _I = V _{IH} or V _{IL} ; I _O = 12mA		0.35	0.55		0.65		
I _I	Input leakage current	V _{CC} = 5.5 V; V _I = V _{CC} or GND			1.0		1.0	µA	
I _{CC}	Quiescent supply current; flip-flops	V _{CC} = 5.5V; V _I = V _{CC} or GND; I _O = 0			20.0		80	µA	
ΔI _{CC}	Additional quiescent supply current per input	V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} - 0.6 V			500		850	µA	

NOTE:

1. All typical values are measured at T_{amb} = 25°C.

AC CHARACTERISTICS

GND = 0V; t_r = t_f ≤ 2.5ns; C_L = 50pF; R_L = 1KΩ

SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS					UNIT
				-40 to +85 °C			-40 to +125 °C		
			V _{CC} (V)	MIN	TYP ¹	MAX	MIN	MAX	
t _{PHL/t_{PLH}}	Propagation delay nCP to nQ, nQ̄	Figures 1, 2	1.2		95				ns
			2.0		32	44		56	
			2.7		24	33		41	
			3.0 to 3.6		18 ²	26		33	
			4.5 to 5.5			22		28	

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AC CHARACTERISTICS (Continued)

 $V_{GND} = 0V$; $t_r = t_f \leq 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 1\text{k}\Omega$

SYMBOL	PARAMETER	WAVEFORM	CONDITION $V_{CC}(V)$	-40 to +85 °C			-40 to +125 °C		UNIT
				MIN	TYP ¹	MAX	MIN	MAX	
t_{PHL}/t_{PLH}	Propagation delay $n\bar{R}$ to $nQ, n\bar{Q}$	Figures 1, 2	1.2		95				ns
			2.0		32	44		56	
			2.7		24	33		41	
			3.0 to 3.6		18 ²	26		33	
			4.5 to 5.5			22		28	
t_W	Clock pulse width HIGH or LOW	Figure 2	2.0	34	14		41		ns
			2.7	25	10		30		
			3.0 to 3.6	20	8 ²		24		
			4.5 to 5.5	15			18		
t_W	Reset pulse width LOW	Figure 2	2.0	34	14		41		ns
			2.7	25	10		30		
			3.0 to 3.6	20	8 ²		24		
			4.5 to 5.5	15					
t_{rem}	Removal time $n\bar{R}$ to $n\bar{CP}$	Figure 2	1.2		35				ns
			2.0	24	12		29		
			2.7	18	9		21		
			3.0 to 3.6	14	7 ²		17		
			4.5 to 5.5	11			14		
t_{su}	Set-up time nJ, nK to \bar{CP}	Figure 1	1.2		40				ns
			2.0	26	14		31		
			2.7	19	10		23		
			3.0 to 3.6	15	8 ²		18		
			4.5 to 5.5	12			15		
t_h	Hold time nJ, nK to \bar{CP}	Figure 1	1.2		-10				ns
			2.0	5	-3		5		
			2.7	5	-2		5		
			3.0 to 3.6	5	-2 ²		5		
			4.5 to 5.5	5			5		
f_{max}	Maximum clock pulse frequency	Figure 1	2.0	14	40		12		MHz
			2.7	19	58		16		
			3.0 to 3.6	24	70 ²		20		
			4.5 to 5.5	30			24		

NOTES:

1. Unless otherwise stated, all typical values are measured at $T_{amb} = 25^\circ\text{C}$
2. Typical values are measured at $V_{CC} = 3.3 \text{ V}$.

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AC WAVEFORMS

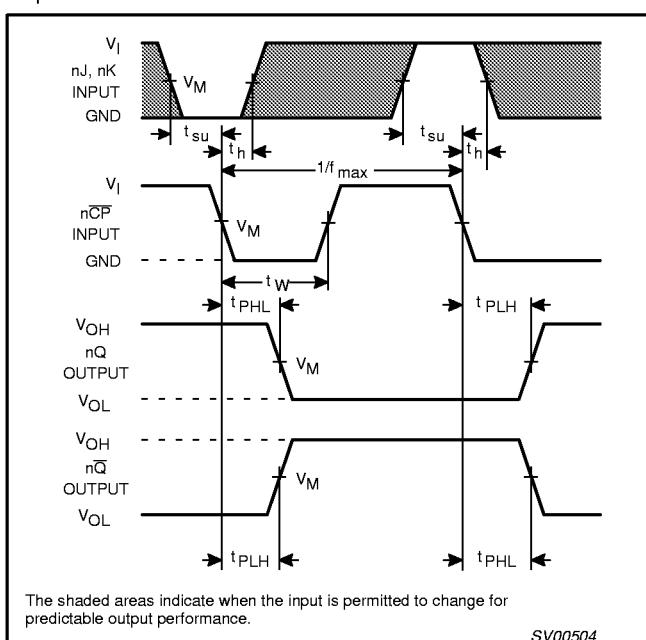
 $V_M = 1.5 \text{ V}$ at $V_{CC} \geq 2.7 \text{ V}$ and $\leq 3.6 \text{ V}$; $V_M = 0.5 \times V_{CC}$ at $V_{CC} < 2.7 \text{ V}$ and $\geq 4.5 \text{ V}$; V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

Figure 1. Clock (nCP) to output (nQ, n \bar{Q}) propagation delays, the clock pulse width, the J and K to nCP set-up and hold times and the maximum clock pulse frequency.

TEST CIRCUIT

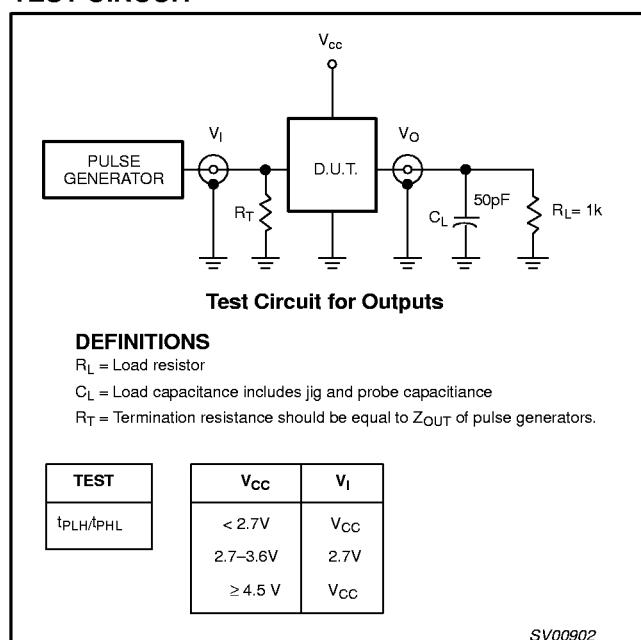


Figure 3. Load circuitry for switching times.

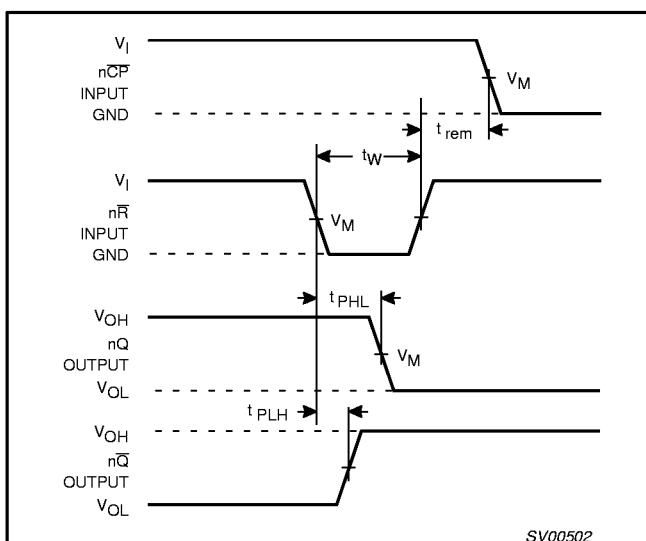


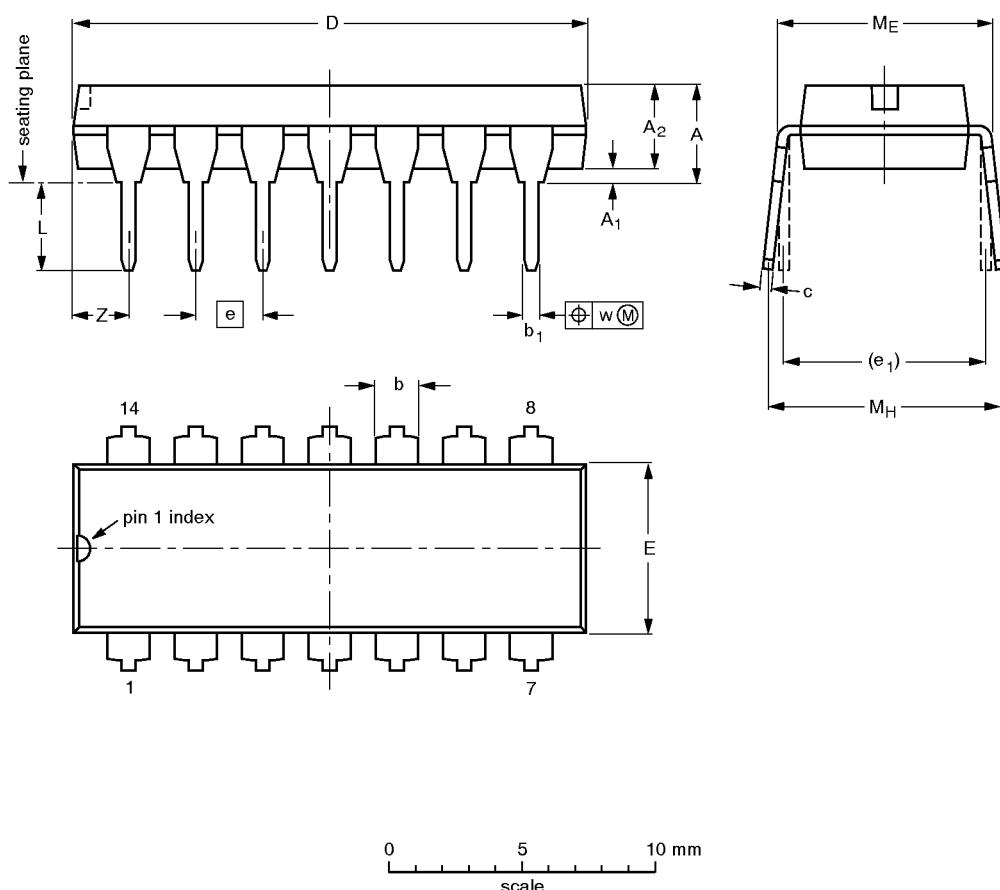
Figure 2. Reset (nR) input to output (nQ, n \bar{Q}) propagation delays, the reset pulse width and the nR to nCP removal time.

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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

- Plastic or metal protrusions of 0.25 mm maximum per side are not included.

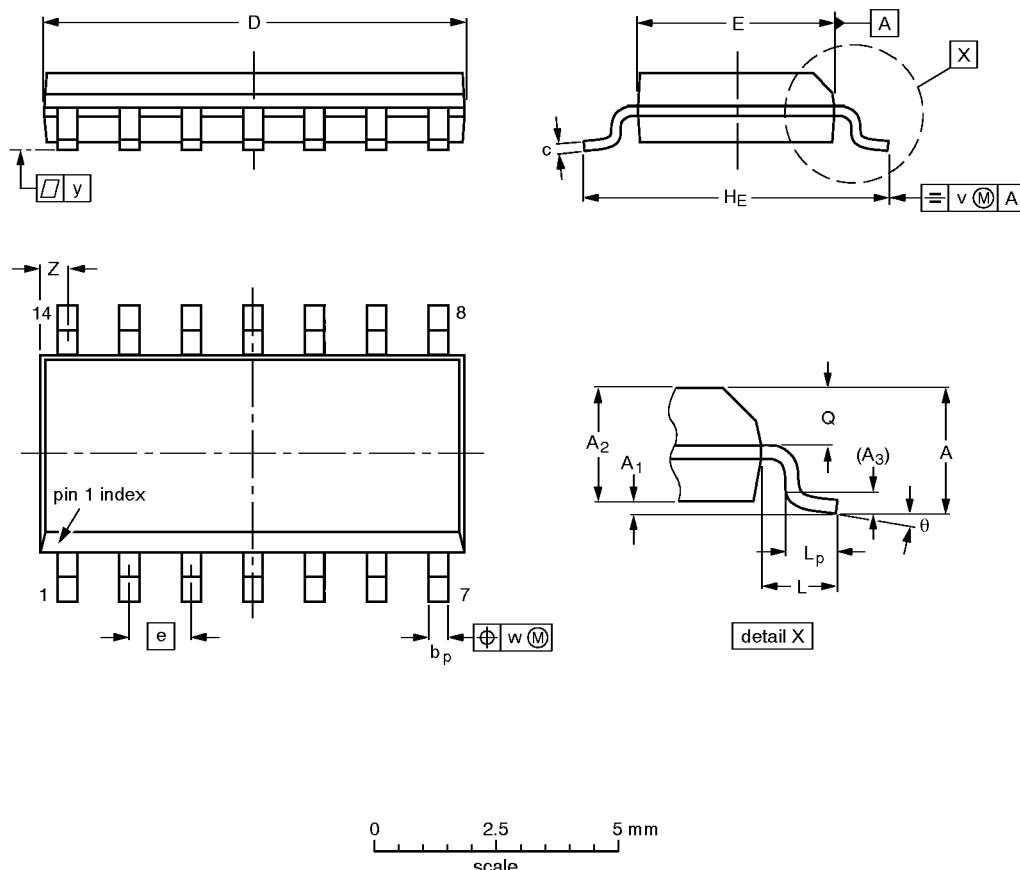
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT27-1	050G04	MO-001AA				92-11-17 95-03-11

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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	1.75 0.10	0.25 1.25	1.45 0.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069 0.0039	0.0098 0.049	0.057 0.049	0.01	0.019 0.014	0.0098 0.0075	0.35 0.34	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

Note

- Plastic or metal protrusions of 0.15 mm maximum per side are not included.

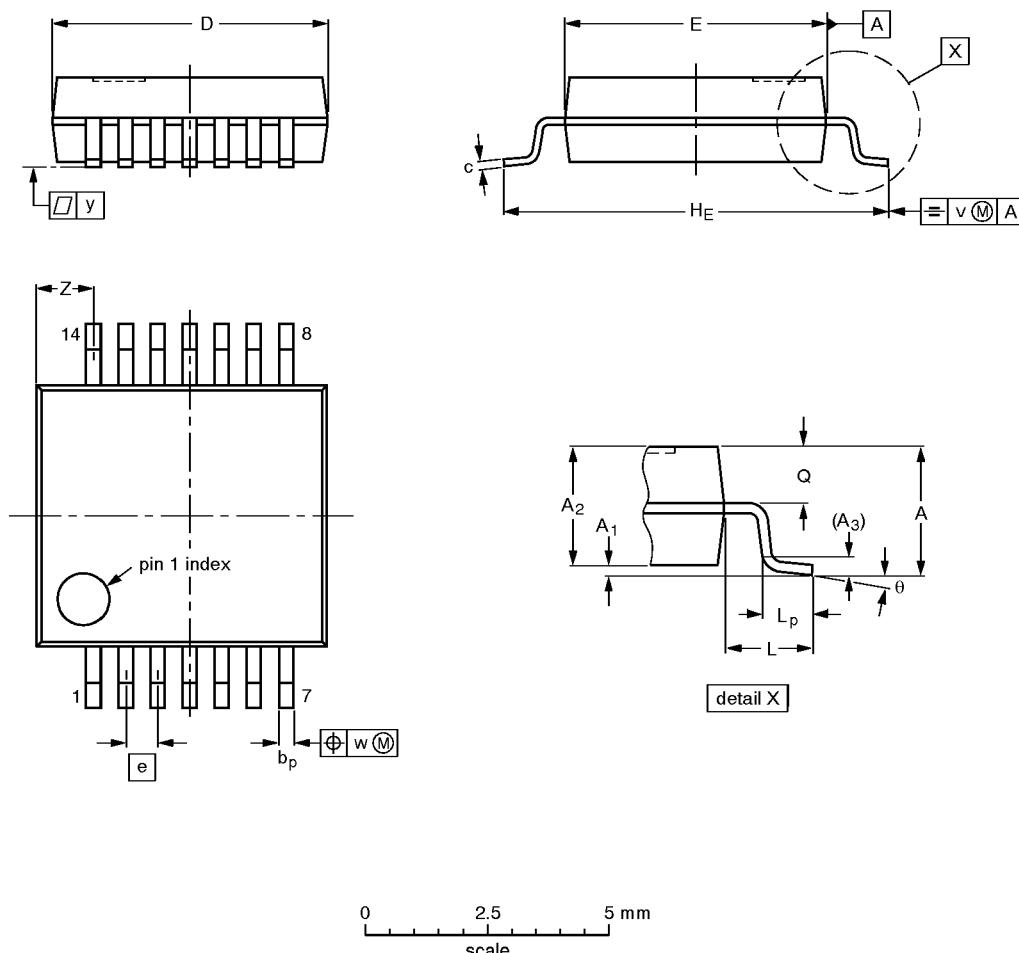
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT108-1	076E06S	MS-012AB				91-08-13- 95-01-23

Dual JK flip-flop with reset; negative-edge trigger

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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	2.0 0.05	0.21 1.65	1.80	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

Note

- Plastic or metal protrusions of 0.25 mm maximum per side are not included.

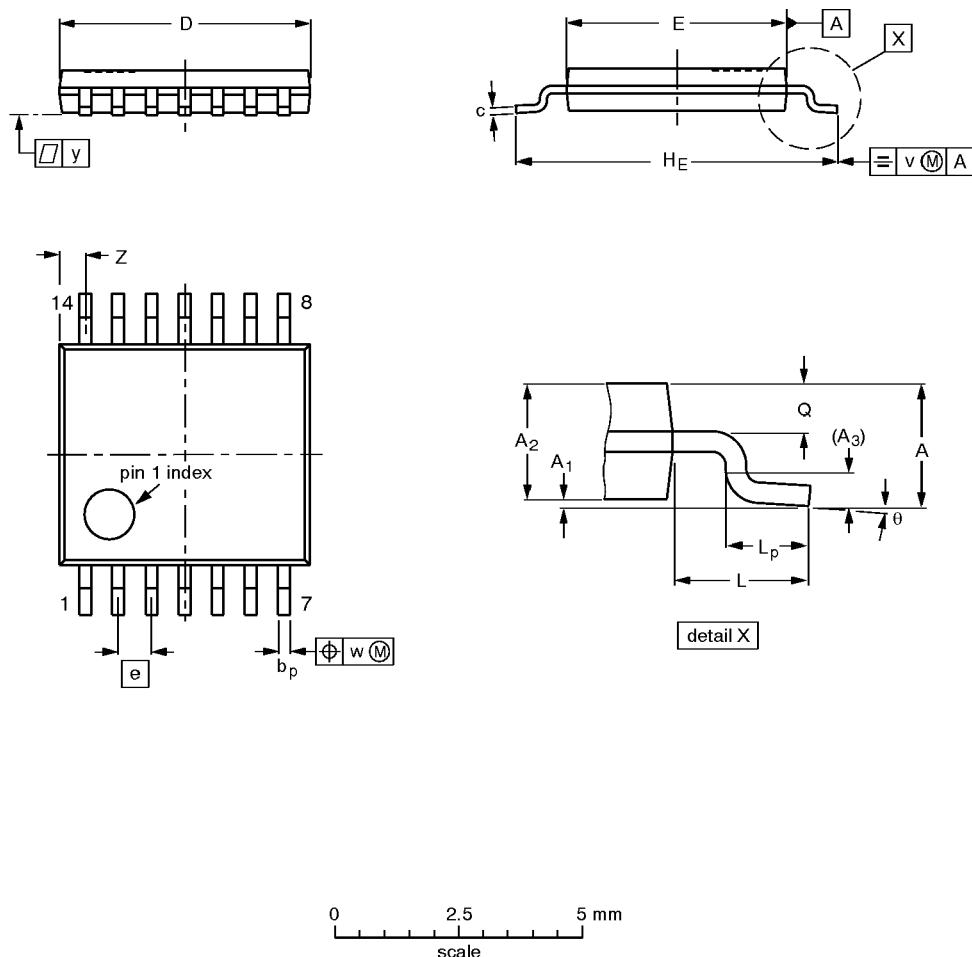
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT337-1		MO-150AB				95-02-04 96-01-18

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	1.10 0.05	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT402-1		MO-153				94-07-12 95-04-04